

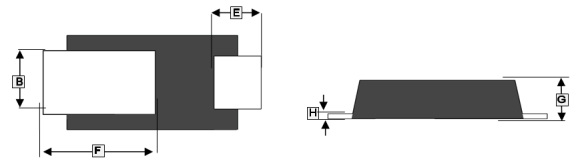
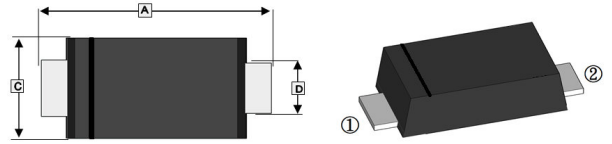
RoHS Compliant Product

A suffix of "-C" specifies halogen-free and RoHS Compliant

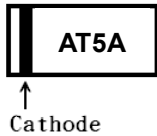
**FEATURES**

- Heatsink Structure
- Low Profile, Typical Thickness 0.65mm
- Low Forward Voltage Drop
- Low Leakage Current
- Moisture Sensitivity: Level 1, Per J-STD-020
- High Temperature Soldering Guaranteed: 260°C/10 Seconds
- Qualified to AEC-Q101 standards for high reliability

**SOD-323WT**



**MARKING**



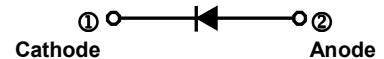
**PACKAGE INFORMATION**

Package	MPQ	Leader Size
SOD-323WT	15K	13 inch

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.30	2.70	E	0.4	0.75
B	0.75	1.00	F	1.1	1.5
C	1.20	1.40	G	0.6	0.73
D	0.55	0.75	H	0.1	0.25

**ORDER INFORMATION**

Part Number	Type
SM4001WTCR-C~SM4005WTCR-C	Lead (Pb)-free and Halogen-free



**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS** (T<sub>A</sub>=25°C unless otherwise specified)

Parameter	Symbol	Part Number					Unit
		SM4001 WTCR-C	SM4002 WTCR-C	SM4003 WTCR-C	SM4004 WTCR-C	SM4005 WTCR-C	
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	V
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	V
Maximum Average Forward Rectified Current	I <sub>F</sub>	1					A
Peak Forward Surge Current @8.3ms Single Half Sine-Wave Superimposed on Rate Load	I <sub>FSM</sub>	20					A
Maximum Instantaneous Forward Voltage @I <sub>F</sub> =1A	V <sub>F</sub>	1.1					V
Maximum DC Reverse Current @Rated DC Blocking Voltage	I <sub>R</sub>	T <sub>A</sub> =25°C					μA
		T <sub>A</sub> =125°C					
Typical Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =0.5A, I <sub>R</sub> =1A I <sub>rr</sub> =0.25A					μs
Typical Junction Capacitance	C <sub>J</sub>	4V, 1MHz					pF
Typical Thermal Resistance from Junction-Ambient <sup>1</sup>	R <sub>θJA</sub>	84					°C/W
Typical Thermal Resistance from Junction-Lead <sup>1</sup>	R <sub>θJL</sub>	3					
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>STG</sub>	-55~150					°C

Note:

1. The thermal resistance from junction to ambient or lead, mounted on P.C.B with 5×5mm copper pads, 2 OZ, FR4 PCB.

**CHARACTERISTIC CURVES**

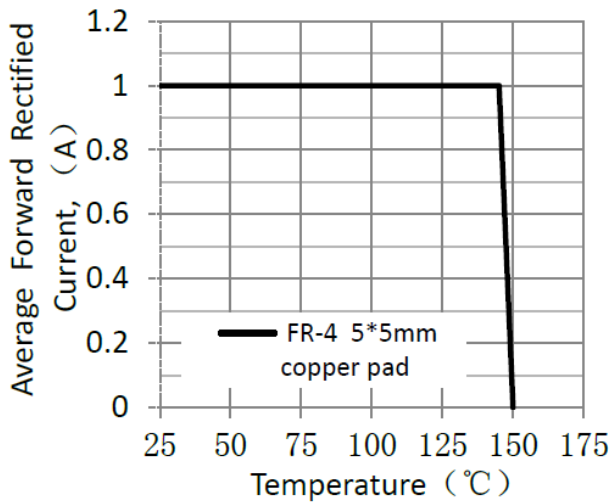


Figure 1. Forward Current Derating Curve

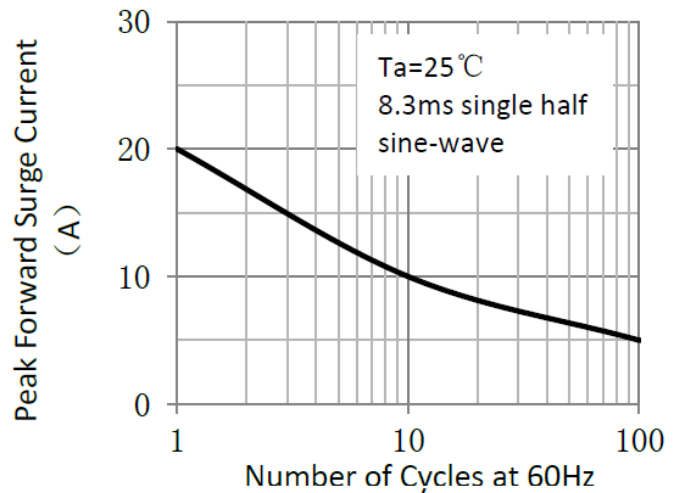


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

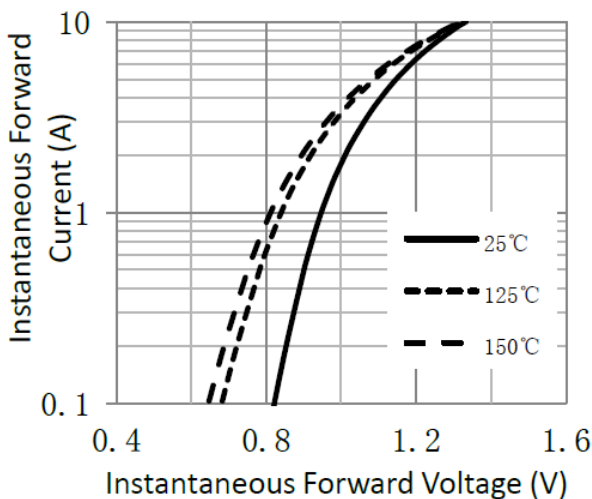


Figure 3. Typical Instantaneous Forward Characteristics

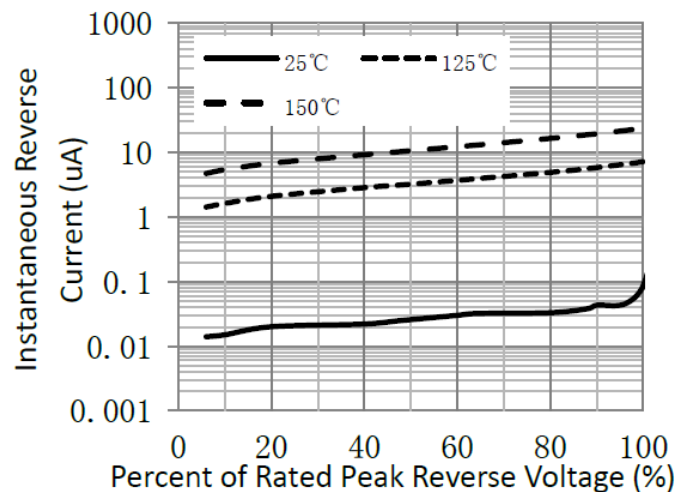


Figure 4. Typical Reverse Characteristics

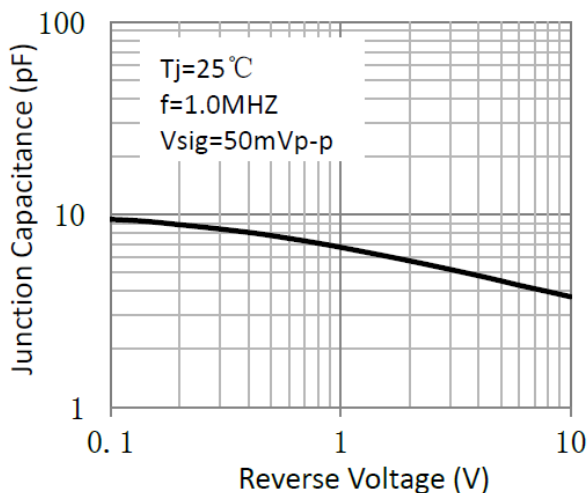


Figure 5. Typical Junction Capacitance